

## 8 Channel MOSFET Array Monolithic N-Channel Enhancement Mode

### Ordering Information

BV <sub>DSS</sub> / BV <sub>DGS</sub> (min)	R <sub>DS(ON)</sub> (max)	I <sub>D(ON)</sub> (min)	I <sub>DSS</sub> ** @ V <sub>DS</sub> = 100V Max	I <sub>DSS</sub> ** @ V <sub>DS</sub> = 250V Max	Order Number / Package		
					18-Lead Plastic DIP	Plastic SOW-20*	Die†
160V	350Ω	25mA	1nA	—	AN0116NA	AN0116WG	AN0116ND
200V	300Ω	25mA	—	—	AN0120NA	—	AN0120ND
300V	300Ω	25mA	—	—	AN0130NA	—	AN0130ND
320V	350Ω	25mA	—	1nA	AN0132NA	AN0132WG	AN0132ND
400V	350Ω	25mA	—	—	AN0140NA	AN0140WG	AN0140ND

\* Same as SO-20 with 300 mil wide body.

\*\* Average current per channel, measured with all eight channels connected in parallel.

† MIL visual screening available

### Features

- Low drain to source leakage for AN0116 and AN0132
- 160-volt to 400-volt capability
- Interfaces directly to CMOS logic
- 8 independent channels
- Low crosstalk between channels
- Low power dissipation
- Free from secondary breakdown

### Applications

- High impedance/low leakage measurements for bare board testers
- High voltage piezoelectric transducer drivers
- High voltage electroluminescent panel drivers
- High voltage electrostatic array drivers
- General multi-channel driver array

### Absolute Maximum Ratings

Drain-to-Source Voltage	BV <sub>DSS</sub>
Drain-to-Gate Voltage	BV <sub>DGS</sub>
Gate-to-Source Voltage	± 20V
Operating and Storage Temperature	-55°C to +150°C
Soldering Temperature*	300°C
Channel-to-Channel Crosstalk	10mV/V

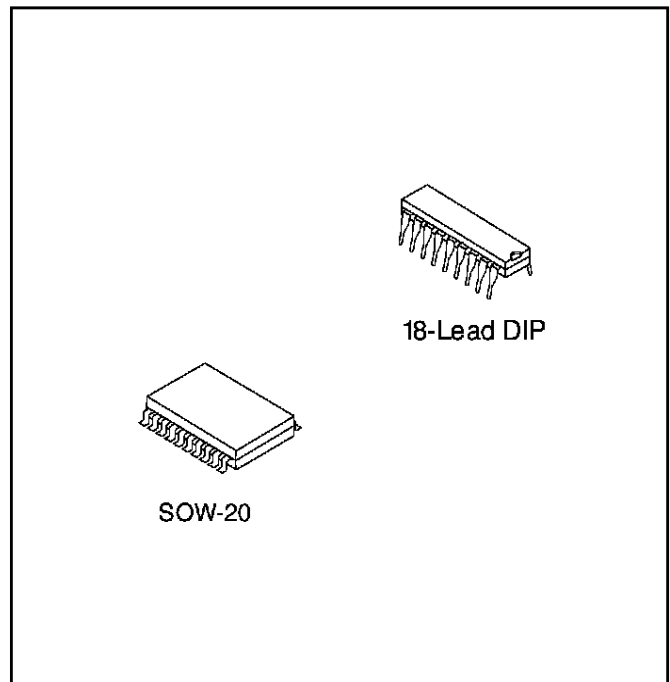
\* Distance of 1.6 mm from case for 10 seconds.

### General Description

The Supertex AN01 series of high voltage arrays is designed to provide the interface between CMOS logic and loads requiring high voltages and intermediate currents. Each circuit consists of eight channels in a common-source configuration with open drains. This design minimizes the number of package leads needed.

The AN0116 and AN0132 are ideally suited for low leakage/high impedance measurement, providing excellent accuracy and resolution for automatic test equipment.

### Package Options



## Thermal Characteristics

Package	$I_D$ (continuous)*	$I_D$ (pulsed)*	Power Dissipation @ $T_C = 25^\circ\text{C}$	$\theta_{JA}$ $^\circ\text{C/W}$	$\theta_{JC}$ $^\circ\text{C/W}$	$I_{DR}$	$I_{DRM}^*$
18 Lead Plastic	30mA	75mA	1.5W	135	83	30mA	75mA
SOW - 20	30mA	75mA	1.4W	110	89	30mA	75mA

\*  $I_D$  (continuous) is limited by max rated  $T_J$ .

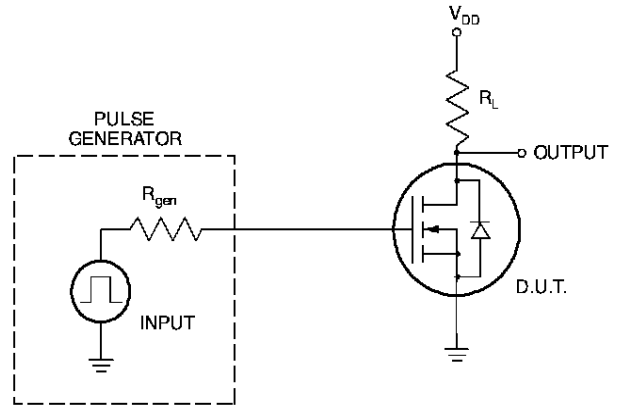
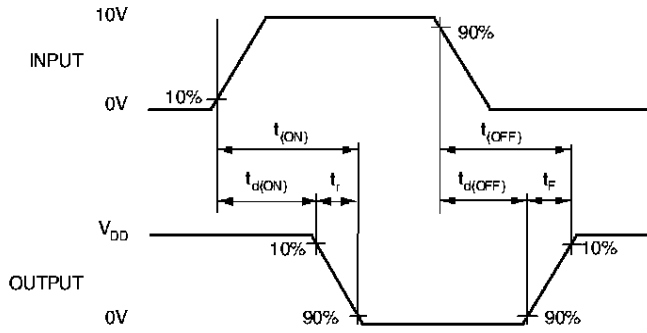
## Electrical Characteristics (@ $25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Min	Typ	Max	Unit	Conditions
$BV_{DSS}$	Drain-to-Source Breakdown Voltage	AN0116	160		V	$V_{GS} = 0, I_D = 100\mu\text{A}$
		AN0120	200			
		AN0130	300			
		AN0132	320	380		
		AN0140	400			
$V_{GS(th)}$	Gate Threshold Voltage	2		5	V	$V_{GS} = V_{DS}, I_D = 1\text{mA}$
$\Delta V_{GS(th)}$	Change in $V_{GS(th)}$ with Temperature		-3.5		mV/ $^\circ\text{C}$	$V_{GS} = V_{DS}, I_D = 1\text{mA}$
$I_{GSS}$	Gate Body Leakage	AN0120		10	nA	$V_{GS} = \pm 20\text{V}, V_{DS} = 0^{(3)}$
		AN0130				
		AN0140				
		AN0116				
AN0132						
$I_{DSS}$	Zero Gate Voltage Drain Current	AN0120		1	$\mu\text{A}$	$V_{GS} = 0, V_{DS} = \text{Max Rating}^{(3)}$
		AN0130		1	mA	$V_{GS} = 0, V_{DS} = 0.8 \text{ Max Rating}$ $T_A = 125^\circ\text{C}^{(3)}$
		AN0116		1	nA	$V_{GS} = 0\text{V}, V_{DS} = 100\text{V}^{(3)}$
				2	$\mu\text{A}$	$V_{GS} = 0\text{V}, V_{DS} = 0.8 \text{ Max Rating}$ $T_A = 125^\circ\text{C}^{(3)}$
		AN0132		1	nA	$V_{GS} = 0\text{V}, V_{DS} = 250\text{V}^{(3)}$
				2	$\mu\text{A}$	$V_{GS} = 0, V_{DS} = 0.8 \text{ Max Rating}$ $T_A = 125^\circ\text{C}^{(3)}$
$I_{D(ON)}$	ON-State Drain Current	25			mA	$V_{GS} = 10\text{V}, V_{DS} = 25\text{V}$
$R_{DS(ON)}$	Static Drain-to-Source ON-State Resistance	AN0120		300	$\Omega$	$V_{GS} = 10\text{V}, I_D = 10\text{mA}$
		AN0130				
		AN0116		350	$\Omega$	$V_{GS} = 10\text{V}, I_D = 10\text{mA}$
		AN0132				
AN0140						
$\Delta R_{DS(th)}$	Change in $R_{DS(th)}$ with Temperature		0.8		$\% / ^\circ\text{C}$	$V_{GS} = 10\text{V}, I_D = 10\text{mA}$
$G_{FS}$	Forward Transconductance	4.0	8.0		mM	$\Delta V_{GS} = 1\text{V}, I_D = 10\text{mA}$
$C_{ISS}$	Input Capacitance		5.0	7.5	pF	$V_{GS} = 0, V_{DS} = 25\text{V}, f = 1\text{MHz}$
$C_{OSS}$	Common Source Output Capacitance		3.0	5.0		
$C_{RSS}$	Reverse Transfer Capacitance		0.8	1.5		
$t_{d(ON)}$	Turn-ON Delay Time		3			
$t_r$	Rise Time		3		ns	$V_{DD} = 25\text{V}, I_D = 10\text{mA}$ $R_{GEN} = 25\Omega$
$t_{d(OFF)}$	Turn-OFF Delay Time		5			
$t_f$	Fall Time		3			
$V_{SD}$	Diode Forward Voltage Drop			1.3	V	$V_{GS} = 0, I_{SD} = 50\text{mA}$

### Notes:

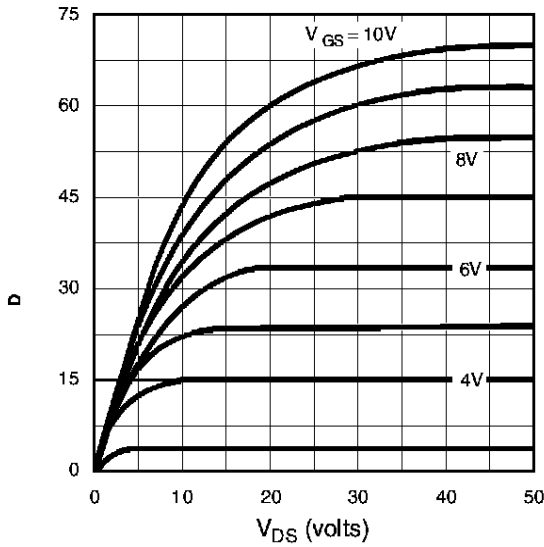
- All D.C. parameters 100% tested at  $25^\circ\text{C}$  unless otherwise stated. (Pulse test: 300 $\mu\text{s}$  pulse, 2% duty cycle.)
- All A.C. parameters sample tested.
- Average current per channel, measured with all 8 channels connected in parallel.

# Switching Waveforms and Test Circuit

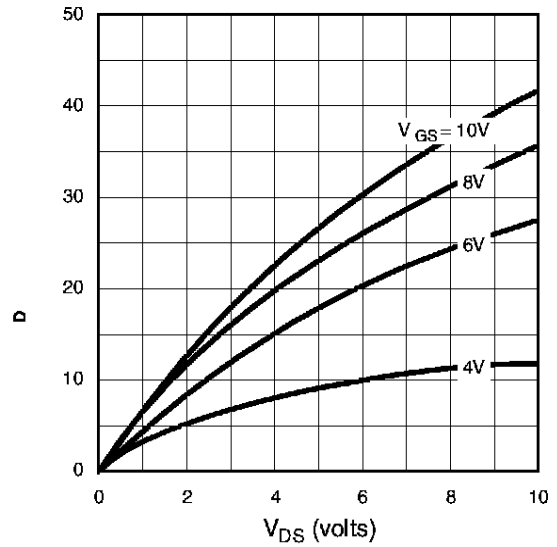


# Typical Performance Curves

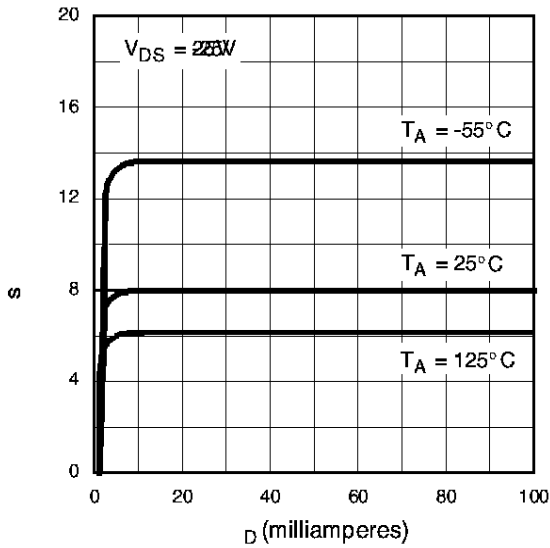
Output Characteristics



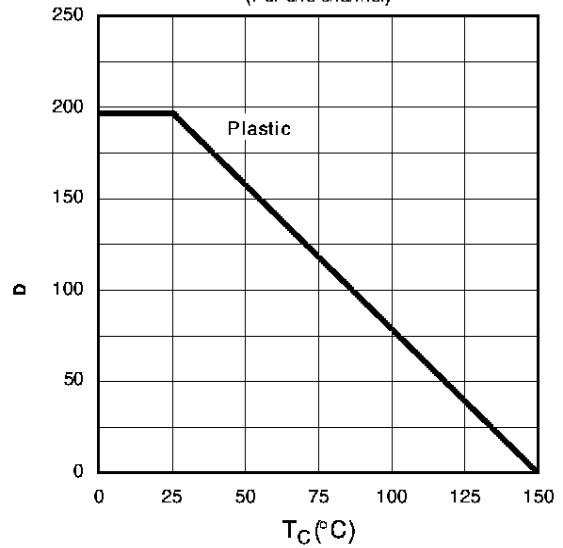
Saturation Characteristics



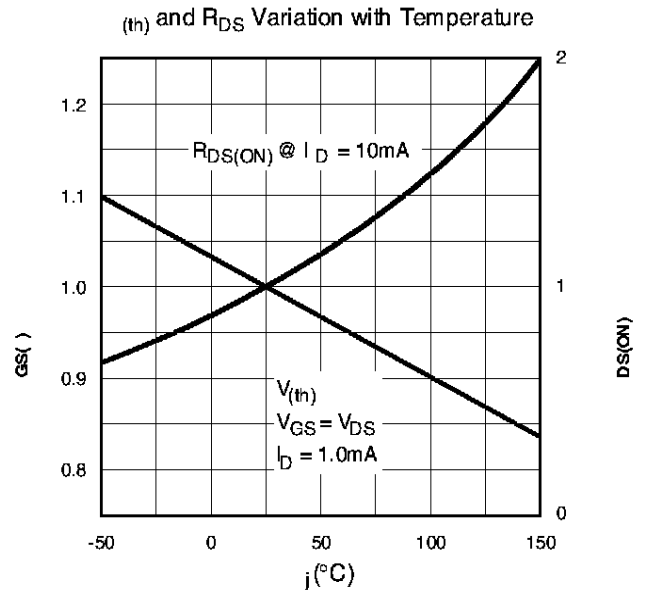
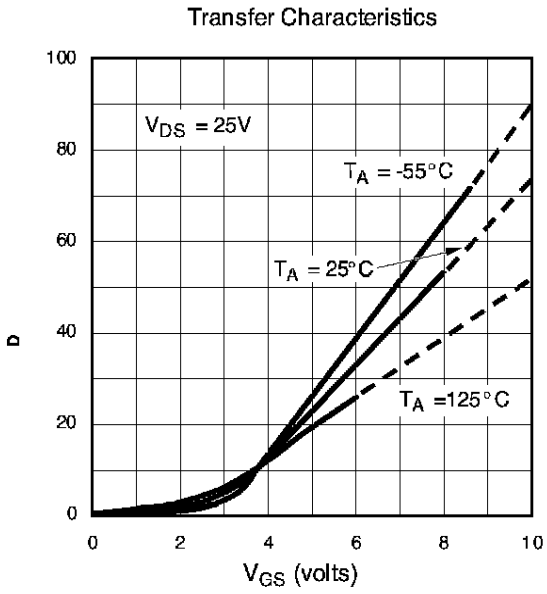
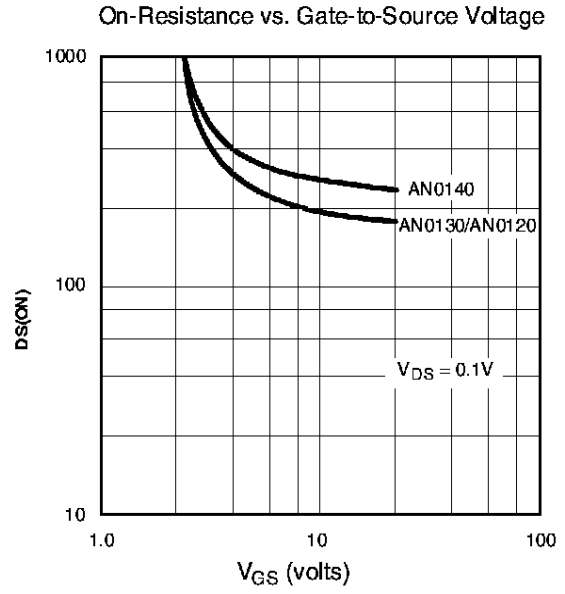
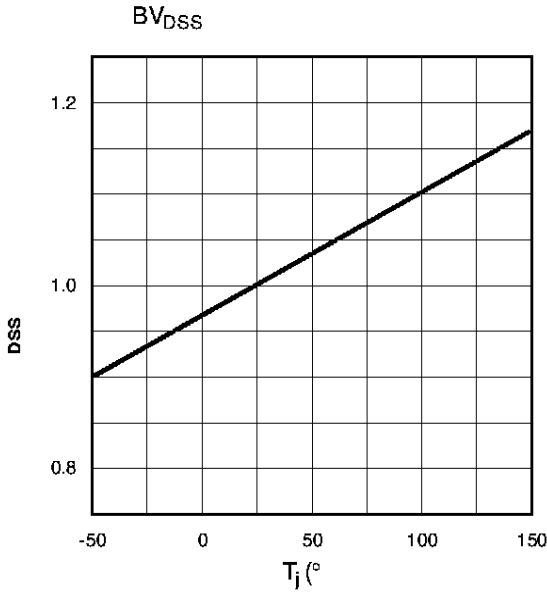
Transconductance vs. Drain Current



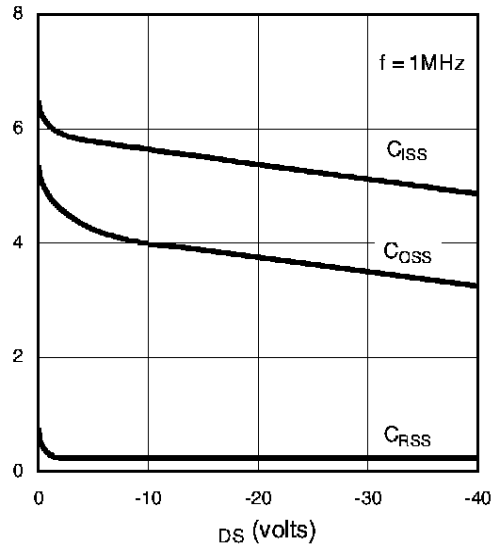
Power Dissipation vs. Case Temperature (For one channel)



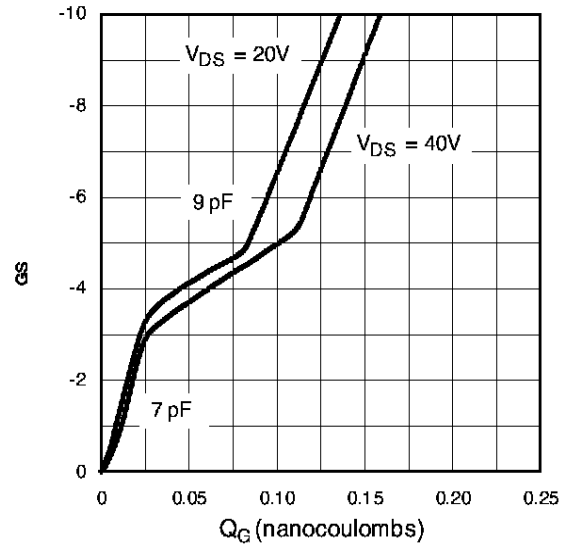
# Typical Performance Curves



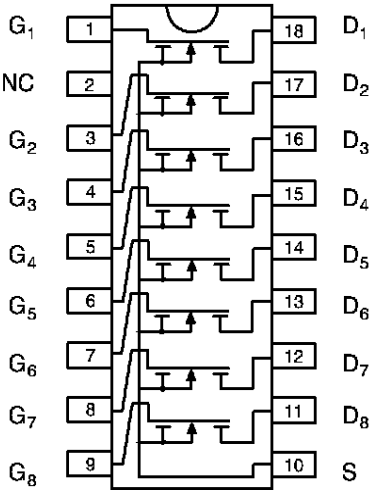
**Capacitance vs. Drain-to-Source Voltage**



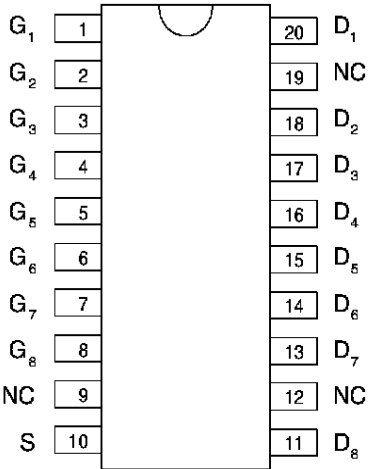
**Gate Drive Dynamic Characteristics**



# Pin Configuration and Schematic



top view  
18-pin DIP



top view  
SOW - 20

